



## DMTH10H025LK3

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	Ι <sub>D</sub> T <sub>C</sub> = +25°C
100V	22mΩ @ V <sub>GS</sub> = 10V	51.7A
	30mΩ @ V <sub>GS</sub> = 6V	44.3A
	$43.7 \text{m}\Omega @ V_{\text{GS}} = 4.5 \text{V}$	36.7A

## Description

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

## Applications

- Power Management Functions
- DC-DC Converters
- Backlighting

### 100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

### Features

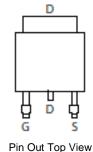
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub> Minimizes Power Losses
- Low Q<sub>G</sub> Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMTH10H025LK3Q</u>)

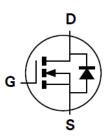
## **Mechanical Data**

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 🚯
- Weight: 0.33 grams (Approximate)



Top View





Equivalent Circuit

## Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH10H025LK3-13	TO252 (DPAK)	2,500/Tape & Reel

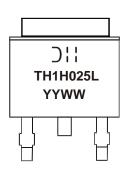
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**

Notes:



) | | = Manufacturer's Marking
TH1H025L = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 18 = 2018)
WW = Week Code (01 to 53)



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	100	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current, $V_{GS} = 10V$ (Note 6) $T_C = +25^{\circ}C$ $T_C = +100^{\circ}C$		Ι <sub>D</sub>	51.7 36.6	А
Pulsed Drain Current (10 $\mu$ s Pulse, T <sub>C</sub> = +25°C, Package Limited )		IDM	200	A
Maximum Continuous Body Diode Forward Current (Note 6)		Is	77	A
Pulsed Body Diode Forward Current (10 $\mu$ s Pulse, T <sub>C</sub> = +25°C, Package Limited)		I <sub>SM</sub>	200	A
Avalanche Current, L = 0.1mH		IAS	15.8	A
Avalanche Energy, L = 0.1mH		E <sub>AS</sub>	12.5	mJ

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	3.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>0JA</sub>	48	°C/W
Total Power Dissipation (Note 6)	PD	100	W	
Thermal Resistance, Junction to Case (Note 6)		R <sub>0JC</sub>	1.5	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +175	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100	—	—	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	-	3	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
		—	17.1	22	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	21.4	30		$V_{GS} = 6V, I_D = 20A$	
		—	28.3	43.7		$V_{GS} = 4.5V, I_D = 20A$	
Diode Forward Voltage	V <sub>SD</sub>	_	_	1.3	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C <sub>iss</sub>	—	1477	—		$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	C <sub>oss</sub>	—	263	_	pF		
Reverse Transfer Capacitance	Crss	—	20	—		I = I I V I I I Z	
Gate Resistance	R <sub>G</sub>	_	1.3	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Q <sub>G</sub>	_	21	_			
Gate-Source Charge	Q <sub>GS</sub>	_	5.7	_	nC	$V_{DD} = 50V, I_D = 20A, V_{GS} = 10V$	
Gate-Drain Charge	Q <sub>GD</sub>	_	3.8	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	6.3	_			
Turn-On Rise Time	t <sub>R</sub>	_	9.4	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_D = 20A, R_G = 6\Omega$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	16.7	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	8.2	_	1		
Reverse Recovery Time	t <sub>RR</sub>	_	38.7	_	ns		
Reverse Recovery Charge	Q <sub>RR</sub>	—	53.7	_	nC	I <sub>F</sub> = 20A, di/dt = 100A/μs	

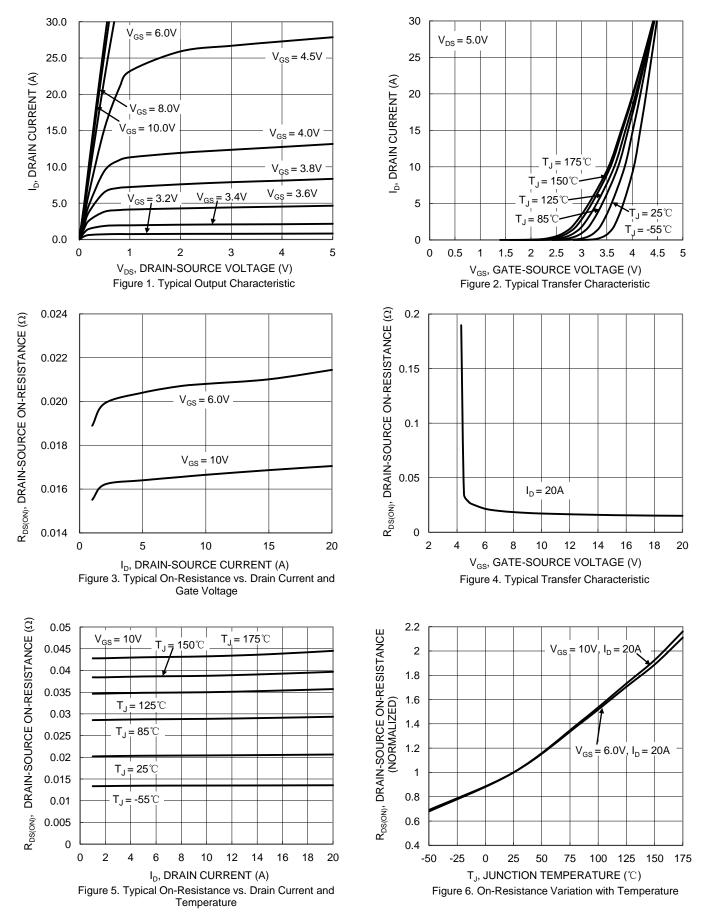
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad). Notes:

7. Short duration pulse test used to minimize self-heating effect.

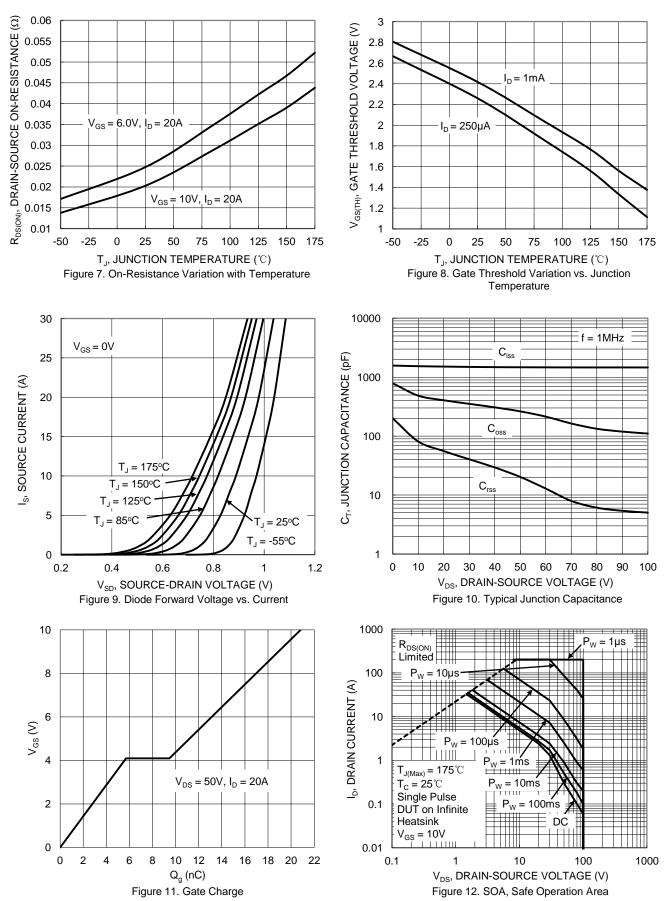
8. Guaranteed by design. Not subject to product testing.



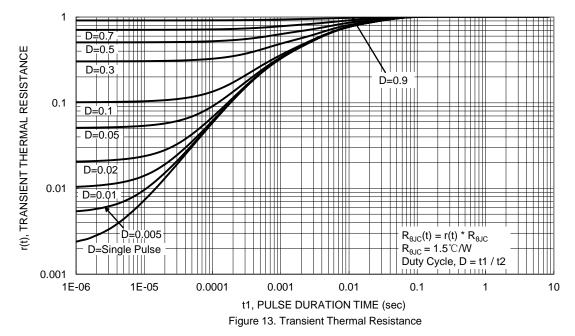
## DMTH10H025LK3









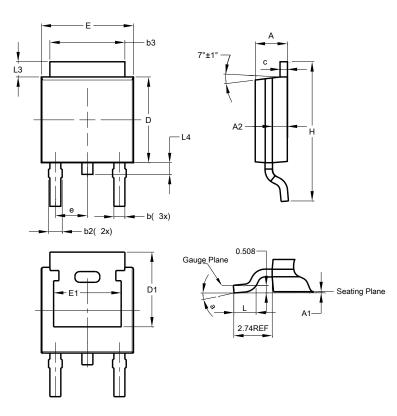




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)

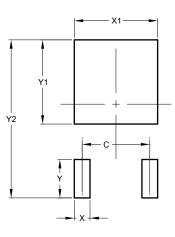


TO252 (DPAK)					
Dim	Min	Min Max T			
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
e	-	-	2.286		
Е	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)			
С	4.572			
Х	1.060			
X1	5.632			
Y	2.600			
Y1	5.700			
Y2	10.700			



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